

Halogen Free & RoHs Compliance

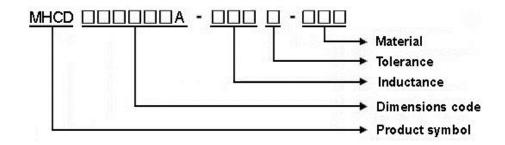
SPECIFICATION FOR APPROVAL

Customer :	超利維				
Customer P/N:					
Drawing No:			IE1-9103	33	
Quantity:	X	Pcs.	DATE:	2019/1/18	
Chilisin P/N:		MHCI	D252010A-	2R2M-A8L	
	SP	ECIFIC	ATION		
	A	CCEPTE	D BY:		
COMPONENT					
ENGINEER					
ELECTRICAL					
ENGINEER					
MECHANICAL					
ENGINEER					
APPROVED					
REJECTED					
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Drawn by 長鈺雯 chang.yuwen	建	Checked 玉雯 chang	-	Approved by JACKY鍾 jacky.chun	



MHCD252010A Series Specification

- **Scope:** This specification applies to Alloy Molding power inductors
- 2 Part Numbering:



3 Rating:

Operating Temperature: - 4 0 °C ~ 1 2 5 °C(Including self - temperature rise)

Storage Temperature: - 4 0 °C ~ 1 2 5 °C(after PCB)

- 5° C ~ 3° C, Humidity 4° 5 % ~ 8° 5 % (before PCB)

4 Marking:

No Marking

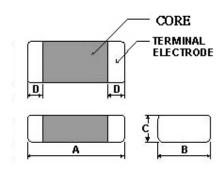
5 Standard Testing Condition

Unless otherwise specified In ca		In case of doubt
Temperature	Ordinary Temperature(15 to 35℃)	20±2 ℃
Humidity	Ordinary Humidity(25 to 85% RH)	60 to 70 % RH



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6 Configuration and Dimensions:



Dimensions in mm

TYPE	MHCD252010A
Α	2.5±0.2
В	2.0±0.2
С	1.0max
D	0.6±0.3

7 Electrical Characteristics:

Part No.	Inductance (uH)	Tolerance (±%)	Test Freq.	Irms(A) Max.(Typ)	Isat(A) Max.(Typ)	RDC(mΩ) Max.(Typ)
MHCD252010A-2R2M-A8L	2.2	20	2MHz,0.2V	1.9(2.1)	2.3(2.7)	120(110)

NOTE

^{1.} Operating temperature range $-40\,^{\circ}\text{C} \sim 125\,^{\circ}\text{C} \text{(Including self - temperature rise)}$

^{2.}Isat for Inductance drop 30% from its value without current.

^{3.}Irms for a 40°C temperature rise from 25°C ambient.

^{4.}All test data is referenced to 25°C ambient

^{5.} Absolute maximum voltage 20VDC

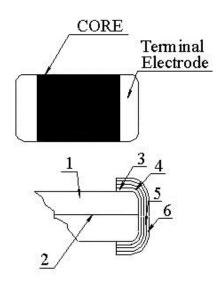
^{6.} Rated current: Isat or Irms, whichever is smaller



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8 MHCD252010A Series

8.1 Construction:



8.2 Material List:

NO	Part	Description	
1	Core	Metal Powder	
2 Wire		Copper wire	
3 Sputter/Platin		g Cu	
4	Silver Electrode	Ag	
5 Plating		Ni	
6	Plating	Sn	



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9 Reliability Of Molding power inductors

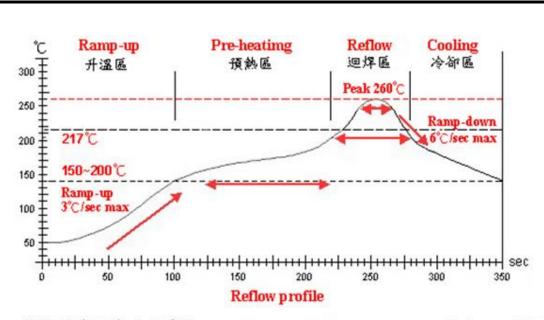
1-1.Mechanical Performance

No	Item	Specification	Test Method
1-1-1	Flexure Strength	The forces applied on the right	Test device shall be soldered on the substrate
		conditions must not damage	Substrate Dimension: 100x40x1.6mm
		the terminal electrode and the	Deflection: 2.0mm
		metal body	Keeping Time: 30sec
1-1-2	Vibration	Appearance:No damage (for	Test device shall be soldered on the substrate
		microscope of CASTOR MZ-45 20X)	Oscillation Frequency: 10 to 55 to 10Hz for 1min
		Inductance change shall be	Amplitude: 1.5mm
		within ±20%	Time: 2hrs for each axis (X, Y & Z), total 6hrs
1-1-3	Resistance to Soldering Heat	Appearance: No damage	Pre-heating: 150°C, 1min
		More than 75% of the terminal.	Solder Composition: Sn/Ag3.0/Cu0.5(Pb-Free)
		electrode should be covered	Solder Temperature: 260±5°C
		with solder.	Immersion Time: 10±1sec
		Inductance: within ±20% of	
		initial value	
1-1-4	Solder ability	The electrodes shall be at	Pre-heating: 150°C, 1min
		least 95% covered with new	Solder Composition: Sn/Ag3.0/Cu0.5(Pb-Free)
		solder coating	Solder Temperature: 245±5°C
			Immersion Time: 4±1sec
1-1-5	Terminal Strength Test	No split termination	Test device shall be soldered on the substrate,
		Chip	then apply a force in the direction of the arrow.
			Force : 5N
		F	Keeping Time: 10±1sec
		Mounting Pad	

1-2. Environmental Performance

No	Item	Specification	Test Method				
1-2-1	Temperature Cycle Appearance: No damage		One cycle:				
		Inductance:within±20% of	Step	Temperature (°ℂ)	Time (min)		
		initial value	1	-40±3	30		
			2	25±2	3		
			3	125±3	30		
			4	25±2	3		
			Total: 100	cycles	_		
			Measured	after exposure in the room co	ndition for 24hrs		
1-2-2	-2-2 Humidity Resistance		Temperatu	Temperature: 60±2°C			
			Relative H	umidity: 90 ~ 95% / Time: 500	hrs		
			Measured	after exposure in the room co	ndition for 24hrs		
1-2-3	High		Temperatu	ıre: 85±3°ℂ			
	Temperature Resistance		Relative H	umidity: 0% / Time: 500hrs			
			Measured	after exposure in the room co	ndition for 24hrs		
1-2-4	Low		Temperatu	ıre: -40±3°ℂ			
	Temperature Resistance		Relative H	umidity: 0% / Time: 500hrs			
			Measured	after exposure in the room co	ndition for 24hrs		

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Lead-Free(LF) 標準溫度分析範圍

Refer to J-STD-020C

管制項目 升溫區 預熱區 Item. Ramp-up Pre-heating		迴焊區 Reflow	Peak Temp	冷卻區 Cooling	
温度範圍 Temp.scope	R.T. ~150°C	150℃ ~ 200℃	217℃	260±5°ℂ	Peak Temp. ~ 150°C
標準時間 Time spec.	_	60 ~ 180 sec	60 ~ 150 sec	20 ~ 40 sec	_
實際時間 Time result	-	75 ~ 100 sec	90 ~ 120 sec	20 ~ 35 sec	_

NOTE:

- 1. Re-flow possible times: within 2 times
- 2. Nitrogen adopted is recommended while in re-flow

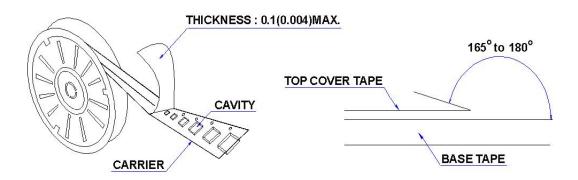


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9 Packaging:

9.1 Packaging -Cover Tape

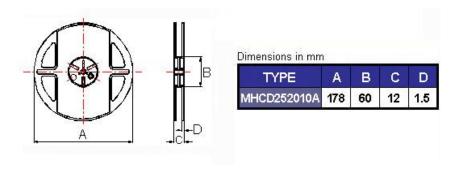
The force for tearing off cover tape is 10 to 100 grams in the arrow direction.



9.2 Packaging Quantity

TYPE	PCS/REEL
MHCD252010A	3000

9.3 Reel Dimensions

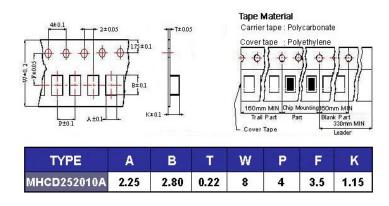




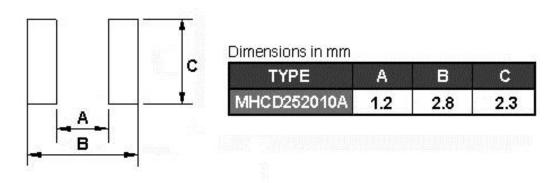
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9 Packaging:

9.4 Tape Dimensions in mm



10 Recommended Land Pattern:



11 Note:

- 1. Please make sure that your product has been evaluated and confirmed against your specifications when our product is mounted to your product.
- 2. Do not knock nor drop.
- 3. All the items and parameters in this product specification have been prescribed on the premise that our product is used for the purpose,under the condition and in the environment agreed upon between you and us. You are requested not to use our product deviating from such agreement.
- 4. Please keep the distance between transformer/coil and other components (refer to the standard IEC 950)
- 5. After manufacturing process, there might be slight irregular shape on the edge of the products, and it's a normal phenomenon that can be neglected
- 6. The moisture sensitivity level (MSL) of products is classified as level 1.



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12 Graph:

